



# Product Change Notification

**Change Notification #:** 118370-00  
**Change Title:** Select Intel® Optane™ Persistent Memory 200 Series  
PCN 118370-00, Transport Media, Packaging Update  
**Date of Publication:** July 12, 2021

**Key Characteristics of the Change:**  
Transport Media

## Forecasted Key Milestones:

|   |                  |
|---|------------------|
| <b>Date Customer Must be Ready to Receive Post-Conversion Material:</b> | October 12, 2021 |
|---|------------------|

## Description of Change to the Customer:

The Intel SKUs listed in the products affected table will have the following changes.

- The Packaging Kit is being updated as shown below. The new package offers enhanced protection.

| Current   | New  |
|---|--|
| <p>Photo of tray in box</p>  |  |

## Customer Impact of Change and Recommended Action:

There is no change to the form, fit, or function of the product but Intel encourages customers to understand the change and determine the impact on their applications.

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory.

Milestone dates are estimates and subject to change based on business and operational conditions. Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

## Products Affected/Intel Ordering Codes:

| Marketing Name   | Product Code    | MM#    | Pre Change TA | Post Change TA |
|--|-----------------|--------|---------------|----------------|
| Intel® Optane™ Persistent Memory 128GB Module (1.0) 4 Pack             | NMA1XXD128GPSU4 | 999AVV | J80358-902    | J80358-903     |
| Intel® Optane™ Persistent Memory 256GB Module (1.0) 4 Pack             | NMA1XXD256GPSU4 | 999AVX | J80361-902    | J80361-903     |
| Intel® Optane™ Persistent Memory 512GB Module (1.0) 4 Pack             | NMA1XXD512GPSU4 | 999AW1 | J80364-902    | J80364-903     |
| Intel® Optane™ Persistent Memory 64GB Module (1.0) 4 Pack              | NMA1XXD064GPSU4 | 999C8T | K44808-900    | K44808-901     |
| Intel® Optane™ Persistent Memory 200 Series (128GB PMEM Module) 4 Pack | NMB1XXD128GPSU4 | 999HGR | K69576-202    | K69576-203     |
| Intel® Optane™ Persistent Memory 200 Series (256GB PMEM Module) 4 Pack | NMB1XXD256GPSU4 | 999HH0 | K69577-202    | K69577-203     |
| Intel® Optane™ Persistent Memory 200 Series (512GB PMEM Module) 4 Pack | NMB1XXD512GPSU4 | 999HH2 | K69578-202    | K69578-203     |

## PCN Revision History:

**Date of Revision:**

July 12, 2021

**Revision Number:**

00

**Reason:**

Originally Published PCN



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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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